

#### Description

The IRF7455TRPBF uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

**General Features** 

 $V_{DS} = 30V I_D = 18A$  $R_{DS(ON)} < 6.5m\Omega @ V_{GS} = 10V$  $R_{DS(ON)} < 12m\Omega @ V_{GS} = 4.5V$ 

#### Application

Battery protection

Load switch

Uninterruptible power supply

#### Package Marking and Ordering Information

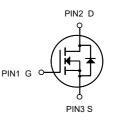
Product ID	Pack	Marking	Qty(PCS)
IRF7455TRPBF	SOP-8	7455 XXXX	3000

## Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Limit	Unit	
Vds	Drain-Source Voltage	30	V	
Vgs	Gate-Source Voltage	±20	V	
I <sub>D</sub>	Drain Current-Continuous	18	А	
I⊳(70 °C)	Drain Current-Continuous(Tc=70°C)	8.2	А	
Ідм	Pulsed Drain Current	42	А	
PD	Maximum Power Dissipation	1.5	W	
Тј,Тѕтб	Operating Junction and Storage Temperature Range	-55 To 150	°C	
Rejc	Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	36	°С/W	

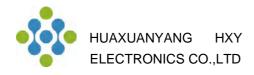






N-Channel MOSFET

N-Channel Enhancement Mode MOSFET



## Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
$\bigtriangleup BV_{\text{DSS}} / \bigtriangleup T_J$	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA            V <sub>GS</sub> =10V , I <sub>D</sub> =10A		0.027		V/°C
Rds(on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =10A		5.5	6.5	-mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =8A		9	12	
$V_{GS(th)}$	Gate Threshold Voltage		1.2	1.5	2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$\sim$ V <sub>GS</sub> -V <sub>DS</sub> , I <sub>D</sub> -2500A		-5.8		mV/°C
		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA
lgss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =10A		5.8		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.2	3.8	Ω
Qg	Total Gate Charge (4.5V)			12.6	17.6	
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		4.2	5.9	nC
$Q_{gd}$	Gate-Drain Charge			5.1	7.1	
T <sub>d(on)</sub>	Turn-On Delay Time			6.2	12.4	
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$		59	106	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =10A		27.6	55	ns
T <sub>f</sub>	Fall Time			8.4	16.8	
Ciss	Input Capacitance			1317	1845	
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		163	228.2	pF
Crss	Reverse Transfer Capacitance			131	183.4	

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,5</sup>				10.3	A
I <sub>SM</sub>	Pulsed Source Current <sup>2,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			42	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , Is=1A , TJ=25°C			1.2	V
t <sub>rr</sub>	Reverse Recovery Time			12.5		nS
Qrr	Reverse Recovery Charge	IF=10A , dI/dt=100A/µs , Tյ=25°C		5		nC

Note :

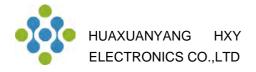
1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =35A

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **IRF7455TRPBF**

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N-Channel Enhancement Mode MOSFET



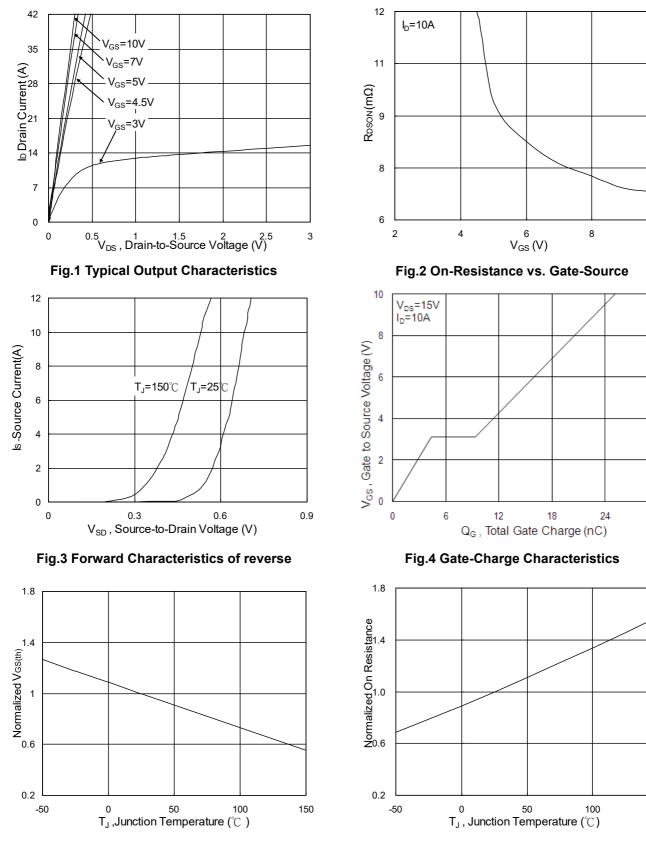
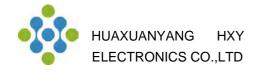


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>

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# IRF7455TRPBF N-Channel Enhancement Mode MOSFET

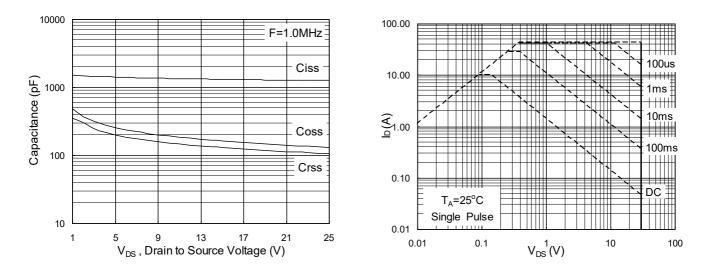
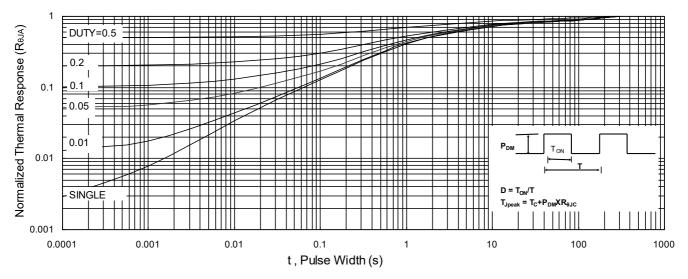


Fig.7 Capacitance

Fig.8 Safe Operating Area





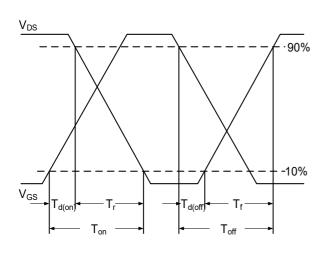


Fig.10 Switching Time Waveform

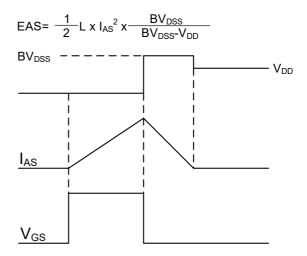
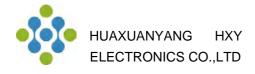
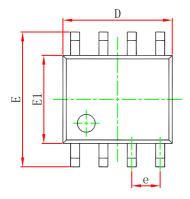
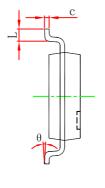


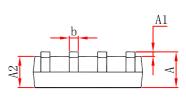
Fig.11 Unclamped Inductive Switching Waveform



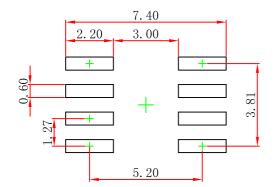
## SOP-8 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



Note: 1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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